

# MOS FIELD EFFECT TRANSISTOR 2SK3296

# SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

#### **DESCRIPTION**

The 2SK3296 is N-Channel MOS FET device that features a low on-state resistance and excellent switching characteristics, designed for low voltage high current applications such as DC/DC converter with synchronous rectifier.

#### **FEATURES**

- 4.5 V drive available
- Low on-state resistance

 $R_{DS(on)1}$  = 12  $m\Omega$  MAX. (VGS = 10 V, ID = 18 A)

Low gate charge

 $Q_G = 30 \text{ nC TYP.}$  ( $I_D = 35 \text{ A}$ ,  $V_{DD} = 16 \text{ V}$ ,  $V_{GS} = 10 \text{ V}$ )

- · Built-in gate protection diode
- · Surface mount device available

# **ORDERING INFORMATION**

PART NUMBER	PACKAGE
2SK3296	TO-220AB
2SK3296-S	TO-262
2SK3296-ZK	TO-263(MP-25ZK)
2SK3296-ZJ	TO-263(MP-25ZJ)

#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (VGS = 0 V)	VDSS	20	V
Gate to Source Voltage (V <sub>DS</sub> = 0 V)	Vgss	±20	V
Drain Current (DC) (Tc = 25°C)	ID(DC)	±35	Α
Drain Current (Pulse) Note	ID(pulse)	±140	Α
Total Power Dissipation (T <sub>A</sub> = 25°C)	P <sub>T1</sub>	1.5	W
Total Power Dissipation (Tc = 25°C)	P <sub>T2</sub>	40	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C

**Note** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%

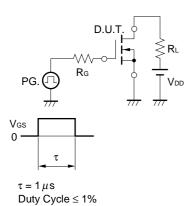
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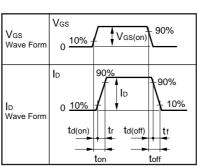


E直包TANKA296HA供A它TERISTICS(TA = 25°C)

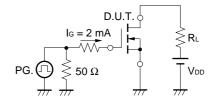
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain Leakage Current	Ioss	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V			10	μΑ
Gate Leakage Current	Igss	V <sub>GS</sub> = ±20 V, V <sub>DS</sub> = 0 V			±10	μΑ
Gate Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.0		2.5	V
Forward Transfer Admittance	yfs	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 18 A	9.0			S
Drain to Source On-state Resistance	RDS(on)1	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 18 A		8.5	12	mΩ
	RDS(on)2	VGS = 4.5 V, ID = 18 A		12	19	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = 10 V		1300		pF
Output Capacitance	Coss	V <sub>GS</sub> = 0 V		570		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		300		pF
Turn-on Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> = 10 V , I <sub>D</sub> = 18 A		70		ns
Rise Time	tr	V <sub>GS(on)</sub> = 10 V		1220		ns
Turn-off Delay Time	td(off)	R <sub>G</sub> = 10 Ω		100		ns
Fall Time	t <sub>f</sub>			180		ns
Total Gate Charge	Q <sub>G</sub>	V <sub>DD</sub> = 16 V		30		nC
Gate to Source Charge	Qgs	V <sub>GS</sub> = 10 V		4.5		nC
Gate to Drain Charge	Q <sub>GD</sub>	I <sub>D</sub> = 35 A		8.0		nC
Diode Forward Voltage	VF(S-D)	I <sub>F</sub> = 35 A, V <sub>GS</sub> = 0 V		1.0		V
Reverse Recovery Time	trr	I <sub>F</sub> = 35 A, V <sub>GS</sub> = 0 V		35		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		23		nC

# **TEST CIRCUIT 1 SWITCHING TIME**



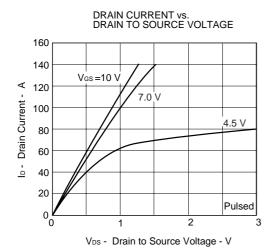


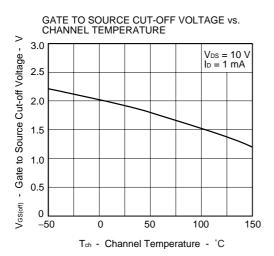
# **TEST CIRCUIT 2 GATE CHARGE**

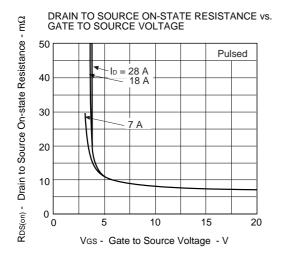


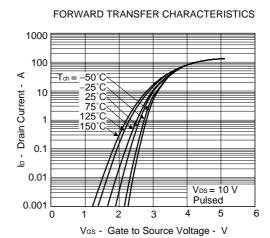


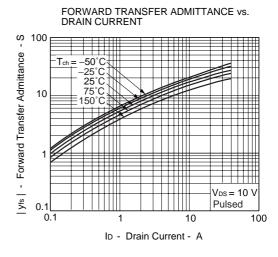
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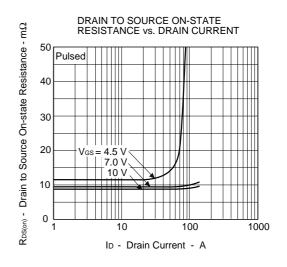






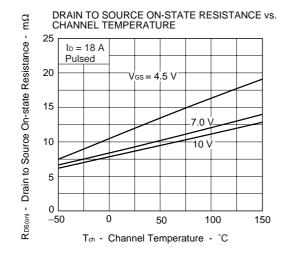


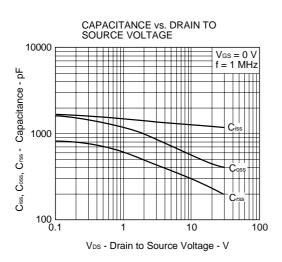


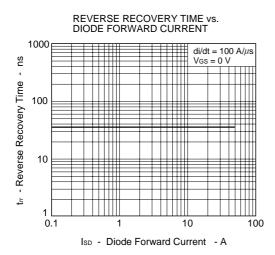


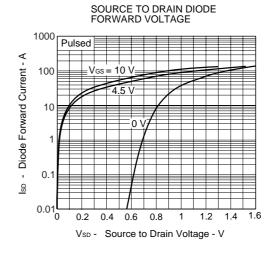


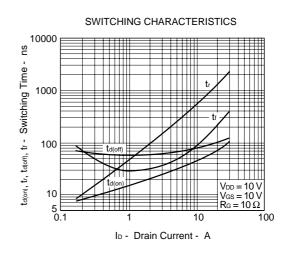
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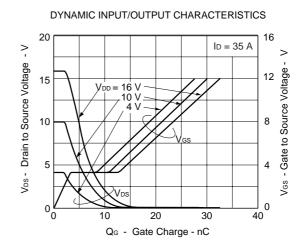






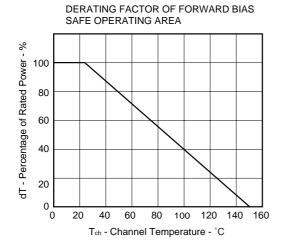


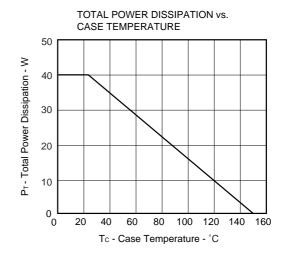


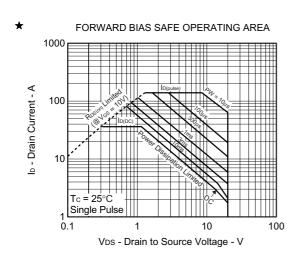




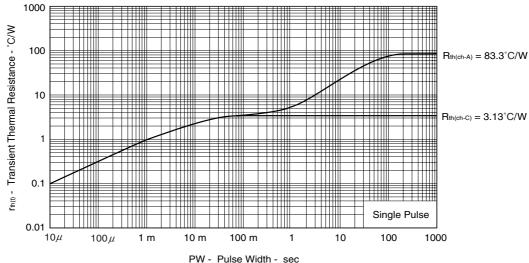
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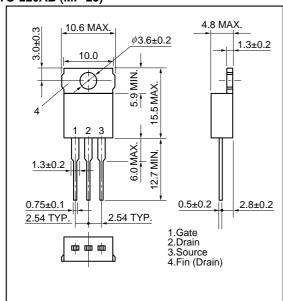


# TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

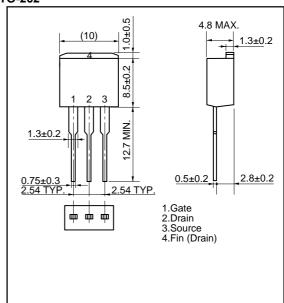


# PACK ASE BRAWINGS ( ) nit: mm)

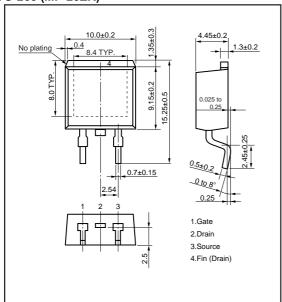
# 1)TO-220AB (MP-25)



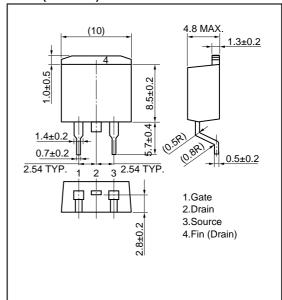
#### 2)TO-262



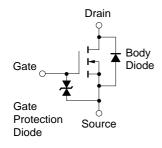
# 3)TO-263 (MP-25ZK)



# 4)TO-263 (MP-25ZJ)



### **EQUIVALENT CIRCUIT**



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD.

> When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.



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